## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Applicant

: Powell, et al.

Serial No.

: 10/080,119

Filed

: February 21, 2002 : METHOD OF FORMING A DIELECTRIC LAYER

Title Docket

: MIO 0060 VA (98-0814.01)

Examiner

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Art Unit

: 2818

CERTIFICATE OF FACS/MILE TRANSMISSION

I hereby certify that this paper is being faccirrole transmitted to the Patent and Trademark
Office (Fax. No. 703/872-9318) on December 9, 2002.

July Of

Reg. No. 48,624

Assistant Commissioner for Patents

Washington, DC 20231

Sir:

## **AMENDMENT**

This paper is being filed in response to the office action mailed on October 8, 2002. Reconsideration is respectfully requested in light of the amendments and remarks below.

## CLEAN VERSION OF THE AMENDMENTS

(A version of the amendments showing the markings is provided in a separate appendix attached to this paper.)

## In the Specification

At page 1, line 1, the title should read:

-- "METHOD OF FORMING A DIELECTRIC LAYER"--

At page 25, the Abstract should read:

"Methods for fabricating a dielectric layer are provided. In one embodiment, a silicon-containing material is deposited on a substrate. The deposited material is processed with a reactive agent to react with silicon atoms of the deposited material to form the dielectric layer. The silicon-containing dielectric layer can allow for improved